35W HIGH POWER RESISTORS

TO263 SURFACE MOUNT





Features :

• 35W high power resistors in TO263(D2-PAK) style.

•Surface mount mold package with matte tin plated flange.

• Heat extraction structure with insulated metal flange.

• 20m Ω to 51K Ω wide resistance range.

Applications:

Non-inductive design suits high frequency applications and high speed pulse circuits.

 UPS, power unit of machines, motor control, drive circuits, automotive, measurements, computers and high frequency

electronics.



Structure and Dimensions (mm) :

HPR3F				
	mm	+/-mm		
А	10.1	+/-0.2		
В	10.3	+/-0.2		
С	4.5	+/-0.2		
D	-	-		
E	5.0	+/-1.0		
F	2.5	+/-0.5		
G	2.2	+/-0.2		
н	2.75	+/-0.2		
J	0.5	+/-0.05		
К	0.75	+/-0.05		
L	1.5	+/-0.05		
М	5.08	+/-0.10		
N	1.5	+/-0.05		



Specifications

Rating Power	35 W			-55 deg C to 25 deg C flange temperature
Rating Power	1 W			Attached on simple foot print.
Heat Resistance	3.3 deg C/W			Resistor hot spot to flange
Resistance Range	0.022-0.068 _Ω	0.1-9.1Ω	10-51KΩ	Note 2
Nominal	E6	E24		Include 2.5, 4.0, 5.0, 8.0
TCR(ppm/deg C)	±250	±100	±50	Note 3.
Tolerance	±5%(J)	±5%(J)	±1% (F) 5% (J)	-
Capacitance	1.44pF			Equivalent parallel capacitance.
Inductance	8.38nH			Equivalent series inductance
Operation Temp.	-55 deg C to+155 deg C			-
Operating Volt.	Either 500V or $\sqrt{P \cdot R}$			P: rating power, R: resistance
Withstanding Volt.	2000 VAC			Terminal and flange, 60 seconds. 1mA
Load Life	+/- 1.0 %			25 deg C, 90 min.ON, 30 min. OFF, 1000h.
Humidity	+/- 1.0 %			40 deg C, 90-95%RH, DC 0.1W, 1000 hours.
Temp. Cycle	+/- 0.25 %			-55 deg C,30 min.,+155 deg C,30 min., 5cyc
Soldering Heat	+/- 0.1 %			350+/-5 deg C, 3 seconds,
Lead Solder ability	Over 95% of surface			230+/-5 deg C, 3 seconds.
Insulation Resistance	Over 1,000 Meg Ω			Between terminals and tab.
Vibration	+/- 0.25 %			IEC60068-2-6, see note 4
Flammability	UL94-V0			-
Weight	1.5 grams			-







Ordering information



Note:

(1) Flange insulation is not necessary between flange and heat-sink, flange and resistor is separated by alumina substrate.

(2) Resistance measurement shall be made at terminal foot portion.

(3) TCR of low resistance will be increased as 300ppm/0.02Ω, 200ppm/0.05Ω, 140ppm/0.1Ω and 80ppm/0.2Ω typically. Testing point is at 5.27mm from bottom of molding of terminals.

(4) Test method is IEC60068-2-6, and specification is sine sweep wave form, 100Hz-2000Hz, 10 cycles, amplitude 0.75mm or 100m/s2, 90minutes. Direction x-y z, Amplitude 0.75mm will be applied under break point Frequency (about 60Hz) and 100m/ s2 over break point
(5) Standard packaging is tape reel, a tape reel contains 500pcs. When small quantity, stick packaging will be used, the stick is made by RoHS PS/PE which contains 50pcs /stick.

This specification is subject to change without notice. Please contact below for the technical support and latest specifications:

